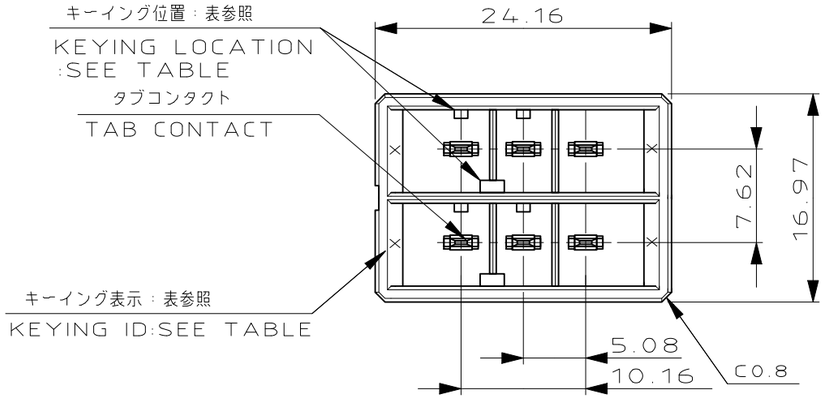
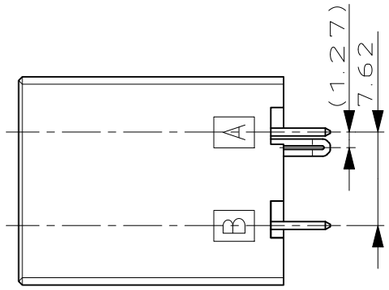
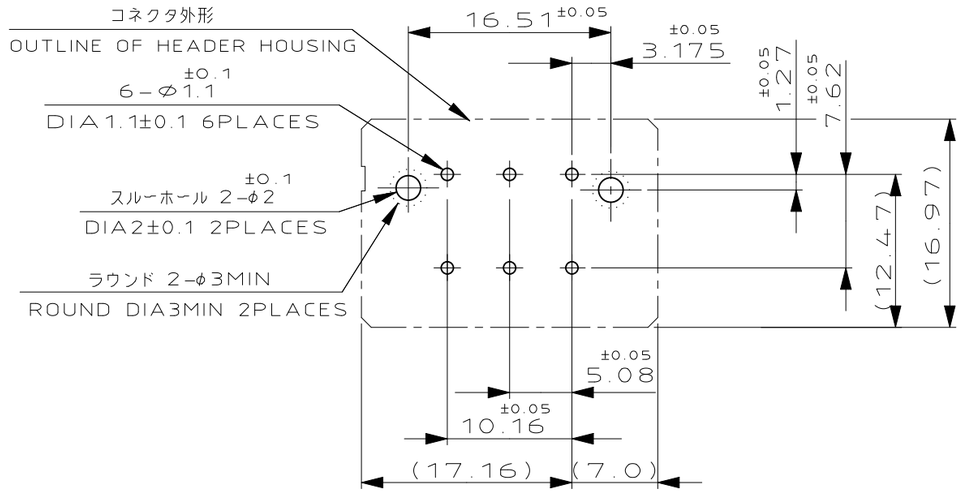
NUMBER 178140

3rd ANGLE PROJECTION

METRIC

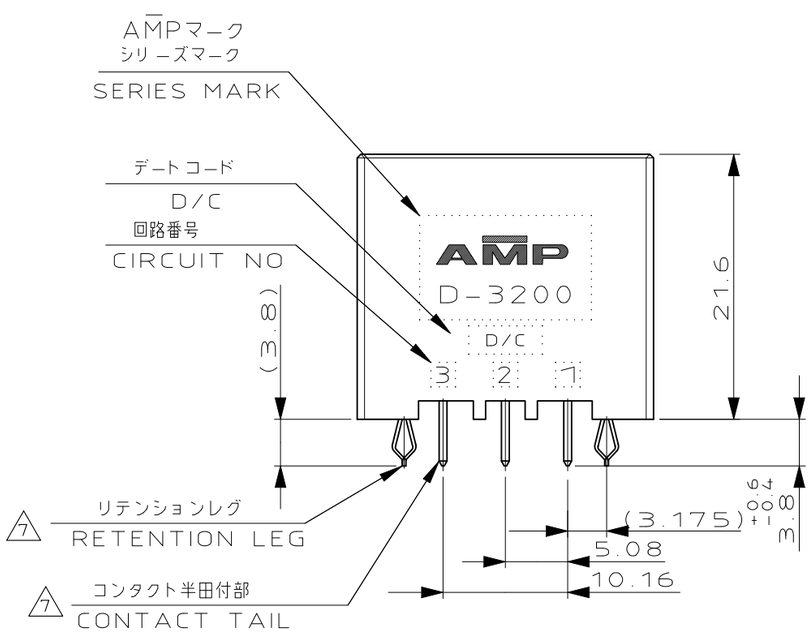






推奨基板取付け穴寸法
PC 基板厚：1.6±0.1
（非累積公差）
（コネクタ搭載面）

RECOMEND PC BOARD HOLE PATTERN
PC BOARD THICKNESS:1.6±0.1
(NOT ACCUMULATE TOLERANCE)
(CONNECTOR MOUNT SIDE)



NOTES

1. MATERIAL:HOUSING:GLASS FILED THERMO PLASTIC,POLYESTER(94V-0),COLOR:BLACK
   CONTACT:COPPER ALLOY
   RETENTION LEG:COPPER ALLOY
2. FINISH(CONTACT AREA):0.38μm PdNi & Au PLATING OVER NICKEL
3. FINISH(CONTACT AREA):0.76μm PdNi & Au PLATING OVER NICKEL
4. FINISH(CONTACT AREA):2.0 μmMIN TIN PLATED OVER NICKEL
5. ~~FINISH(RETENTION LEG): TIN-LEAD PLATED (CONTACT TAIL) OVER NICKEL~~
6. FOR DRAWER
7. FINISH(RETENTION LEG): TIN PLATED (CONTACT TAIL) OVER NICKEL

KEYING LOCATION	A ROW KEYING	B ROW KEYING	FINISH	製品番号 PART NO.
A ROW / B ROW	X	Y	7 4	3-178140-5
			7 3	3-178140-3
			7 2	3-178140-2
A ROW / B ROW	Y	Y	7 4	2-178140-5
			7 3	2-178140-3
			7 2	2-178140-2
A ROW / B ROW	X	X	7 2	6 4-178140-2
			7 4	1-178140-5
			7 3	1-178140-3
			7 2	1-178140-2

LTR	REVISION RECORD	DR	CHK	DATE
G	REVISED PER ECR-25-250800	FZ	RB	03JAN 2025
F1	REVISED PER ECO-11-005030	RK	HMR	23MAR 11

TE Connectivity

WIRE RANGE mm²(AWG −) | INSULATION DIA − mmφ

MATERIAL SEE NOTE 注記参照 | FINISH SEE NOTE 注記参照

DR. 19 APR 94 N.Matsubara | DE. 19 APR 94 N.Matsubara

CHK. 20 APR 94 S.MANABE | APP. 20 APR 94 S.MANABE

NAME DYNAMIC D-3200 5.08X7.62PITCH(V) 6 POS.HDR CONN.ASS'Y

一般公差 (GENERAL TOLERANCE)
10以下 : ±0.3
10を超え 30以下 : ±0.4
30を超え100以下 : ±0.45
角度 : ±3'

SIZE A3 | LOC J | NUMBER C-178140

SCALE 2-1 | REV. G | SHEET 1 OF 1

PRINT DIST

DIMENSIONS IN MILLIMETERS. DO NOT SCALE PRINT

(CUSTOMER DRAWING) 顧客用図面